

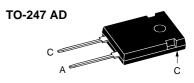
Fast Recovery Epitaxial Diode (FRED)

DSEI 30

 $I_{FAVM} = 26 A$ $V_{RRM} = 1200 V$

V _{RSM}	V _{RRM}	Туре
1200	1200	DSEI 30-12A





= 40 ns

A = Anode, C = Cathode

Symbol	Test Conditions	Maximum Ratings	
FRMS (1)	$T_{VJ} = T_{VJM}$ $T_{C} = 85^{\circ}C$; rectangular, d = 0.5 $t_{p} < 10 \ \mu s$; rep. rating, pulse width limited by T_{VJM}	70 26 375	A A A
I _{FSM}	$T_{VJ} = 45^{\circ}\text{C};$ $t = 10 \text{ ms } (50 \text{ Hz}), \text{ sine}$ $t = 8.3 \text{ ms } (60 \text{ Hz}), \text{ sine}$	200 210	A A
	$T_{VJ} = 150$ °C; $t = 10$ ms (50 Hz), sine $t = 8.3$ ms (60 Hz), sine	185 195	A A
l²t	$T_{VJ} = 45$ °C $t = 10$ ms (50 Hz), sine $t = 8.3$ ms (60 Hz), sine	200 180	A ² s A ² s
	$T_{VJ} = 150$ °C; $t = 10$ ms (50 Hz), sine $t = 8.3$ ms (60 Hz), sine	170 160	A ² s A ² s
T _{VJ} T _{VJM} T _{stg}		-40+150 150 -40+150	°C °C °C
P _{tot}	T _C = 25°C	138	W
M _d	Mounting torque	0.81.2	Nm
Weight		6	g

Symbol	Test Conditions	Cha typ.	acteristic Values max.	
I _R	$T_{VJ} = 25^{\circ}C$ $V_{R} = V_{RRM}$ $T_{VJ} = 25^{\circ}C$ $V_{R} = 0.8 \cdot V_{RRM}$ $T_{VJ} = 125^{\circ}C$ $V_{R} = 0.8 \cdot V_{RRM}$		750 250 7	μΑ μΑ mA
V _F	$I_F = 30 \text{ A};$ $T_{VJ} = 150^{\circ}\text{C}$ $T_{VJ} = 25^{\circ}\text{C}$		2.2 2.55	V V
V _{TO}	For power-loss calculations only $T_{VJ} = T_{VJM}$		1.65 18.2	V mΩ
R _{thJC} R _{thCK} R _{thJA}		0.25	0.9 35	K/W K/W K/W
t _{rr}	$I_F = 1 \text{ A}; -di/dt = 100 \text{ A/}\mu\text{s}; V_R = 30 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$	40	60	ns
I _{RM}	V_R = 540 V; I_F = 30 A; $-di_F/dt$ = 240 A/ μ s L \leq 0.05 μ H; T_{VJ} = 100°C	16	18	Α

Features

- International standard package JEDEC TO-247 AD
- · Planar passivated chips
- Very short recovery time
- · Extremely low switching losses
- Low I_{RM}-values
- Soft recovery behaviour
- Epoxy meets UL 94V-0

Applications

- Antiparallel diode for high frequency switching devices
- Anti saturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- · Inductive heating and melting
- Uninterruptible power supplies (UPS)
- · Ultrasonic cleaners and welders

Advantages

- · High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- · Low noise switching
- Low losses
- Operating at lower temperature or space saving by reduced cooling

IXYS reserves the right to change limits, test conditions and dimensions

 $[\]oplus$ I $_{FAVM}$ rating includes reverse blocking losses at T $_{VJM},\ V_R=0.8\ V_{RRM},\ duty\ cycle\ d=0.5$ Data according to IEC 60747



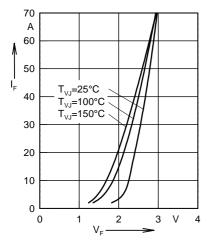


Fig. 1 Forward current versus voltage drop.

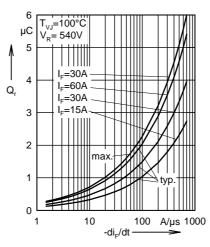


Fig. 2 Recovery charge versus -di_F/dt.

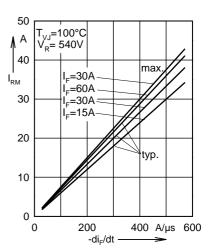


Fig. 3 Peak reverse current versus -di_/dt.

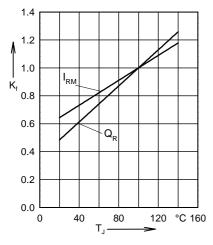


Fig. 4 Dynamic parameters versus junction temperature.

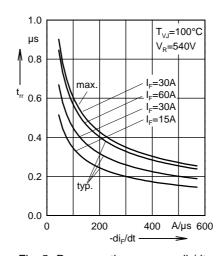


Fig. 5 Recovery time versus -di_F/dt.

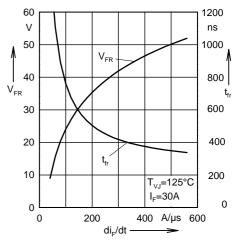


Fig. 6 Peak forward voltage versus di_E/dt.

Dim.

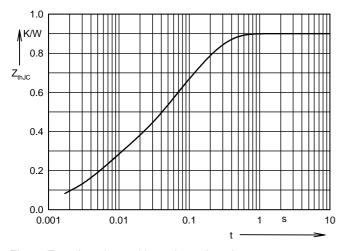


Fig. 7 Transient thermal impedance junction to case.

E D	F A B	
<u>G</u> K	H A A	M

Dimensions

	Min.	Max.	Min.	Max.
A B	19.81 20.80	20.32 21.46	0.780 0.819	0.800 0.845
ОО	15.75 3.55	16.26 3.65	0.610 0.140	0.640 0.144
шғ	4.32 5.4	5.49 6.2	0.170 0.212	0.216 0.244
G H	1.65	2.13 4.5	0.065	0.084 0.177
J K	1.0 10.8	1.4 11.0	0.040 0.426	0.055 0.433
L M	4.7 0.4	5.3 0.8	0.185 0.016	0.209 0.031
N	2.2	2.54	0.087	0.102

Millimeter

Inches